

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	4	"2003052404"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/23 12:43
L2	2	"20030052404"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/23 12:43
L3	655759	(lead leadframe multilayer (multi adj (metal trace wiring layer))) with (edge border expos\$4 end bottom surface)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/23 13:15
L4	28648	(anchor\$4 indent\$4 groove concav\$4) with 3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/23 13:16
L5	3289	4 with (insulat\$4 epoxy encapsulat\$ encase resin)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/23 13:36
L6	2623	(hole thru through throughhole via opening) and 5	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/23 13:37
L7	1346	(flipchip (flip adj chip) semiconductor electronic die chip) and 6	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/23 13:39

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